

General Description

The MDF3N50 uses advanced Magnachip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

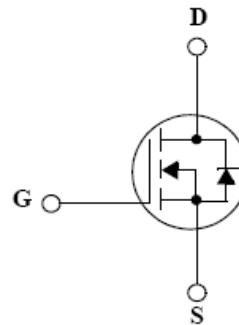
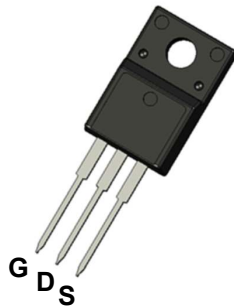
MDF3N50 is suitable device for SMPS, HID and general purpose applications.

Features

- $V_{DS} = 500V$
- $I_D = 2.8A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} \leq 2.5\Omega$ @ $V_{GS} = 10V$

Applications

- Power Supply
- HID
- High Current, High Speed Switching



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Drain-Source Voltage	V_{DSS}	500	V	
Gate-Source Voltage	V_{GSS}	±30	V	
Continuous Drain Current	I_D	$T_C=25^\circ C$	2.8	A
		$T_C=100^\circ C$	1.7	A
Pulsed Drain Current ⁽¹⁾	I_{DM}	11.2	A	
Power Dissipation	P_D	$T_C=25^\circ C$	30.5	W
		Derate above 25 °C	0.24	W/°C
Peak Diode Recovery dv/dt ⁽³⁾	dv/dt	4.5	V/ns	
Repetitive Pulse Avalanche Energy ⁽⁴⁾	E_{AR}	4.5	mJ	
Single Pulse Avalanche Energy ⁽⁴⁾	E_{AS}	170	mJ	
Junction and Storage Temperature Range	T_J, T_{stg}	-55~150	°C	

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance, Junction-to-Case ⁽¹⁾	$R_{\theta JC}$	4.1	

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDF3N50	-55~150°C	TO 220F	Tube	Halogen Free

Electrical Characteristics (Ta =25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250\mu A, V_{GS} = 0V$	500	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	3.0	-	5.0	
Drain Cut-Off Current	I_{DSS}	$V_{DS} = 500V, V_{GS} = 0V$	-	-	1	μA
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 1.4A$	-	2.1	2.5	Ω
Forward Transconductance	g_{fs}	$V_{DS} = 30V, I_D = 1.4A$	-	4.8	-	S
Dynamic Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 400V, I_D = 2.8A, V_{GS} = 10V^{(3)}$	-	6.75	-	nC
Gate-Source Charge	Q_{gs}		-	2	-	
Gate-Drain Charge	Q_{gd}		-	2.6	-	
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	-	285	-	pF
Reverse Transfer Capacitance	C_{rss}		-	1.6	-	
Output Capacitance	C_{oss}		-	25	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 250V, I_D = 2.8A, R_G = 25\Omega^{(3)}$	-	9.0	-	ns
Rise Time	t_r		-	19.2	-	
Turn-Off Delay Time	$t_{d(off)}$		-	14.6	-	
Fall Time	t_f		-	9.6	-	
Drain-Source Body Diode Characteristics						
Maximum Continuous Drain to Source Diode Forward Current	I_S	$I_S = 2.8A, V_{GS} = 0V$	-	2.8	-	A
Source-Drain Diode Forward Voltage	V_{SD}		-	-	1.4	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 2.8A, di/dt = 100A/\mu s^{(3)}$	-	190	-	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	0.9	-	μC

Note :

1. Pulse width is based on $R_{\theta JC}$ & $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, pulse width limited by junction temperature $T_J(MAX) = 150^\circ C$.
3. $I_{SD} \leq 2.8A$, $di/dt \leq 200A/\mu s$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$
4. $L = 40mH$, $I_{AS} = 2.8A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$

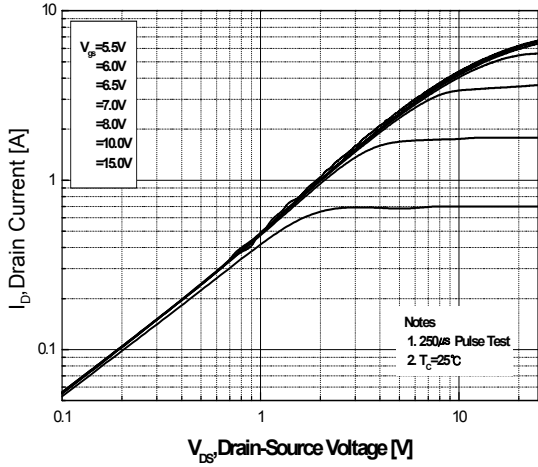


Fig.1 On-Region Characteristics

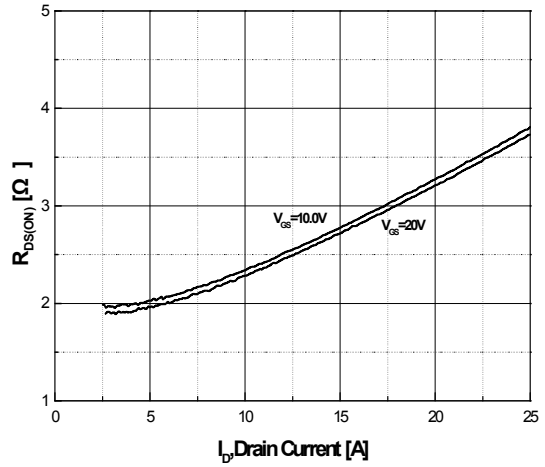


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

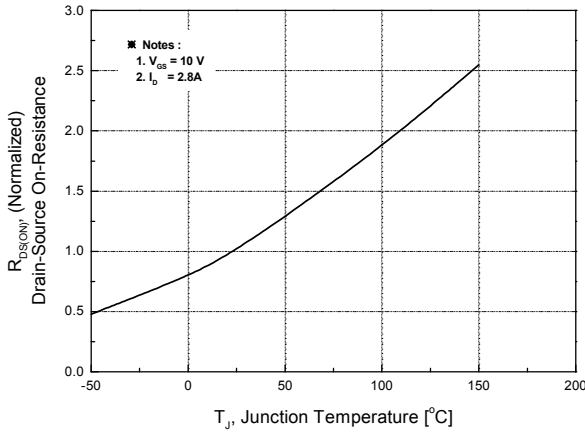


Fig.3 On-Resistance Variation with Temperature

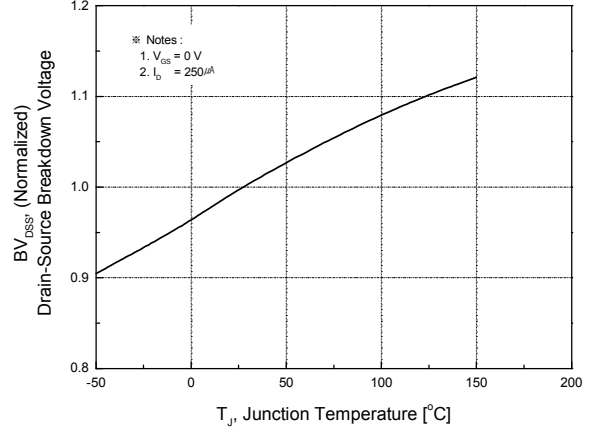


Fig.4 Breakdown Voltage Variation vs. Temperature

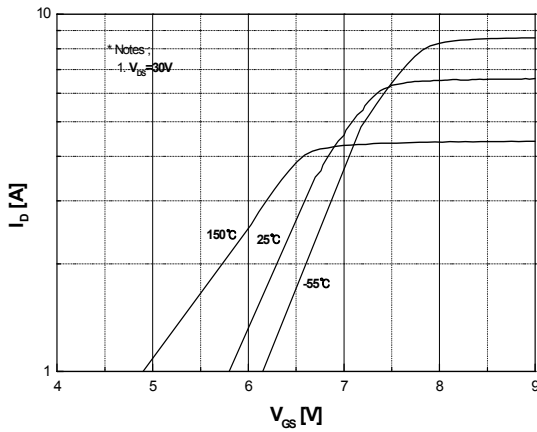


Fig.5 Transfer Characteristics

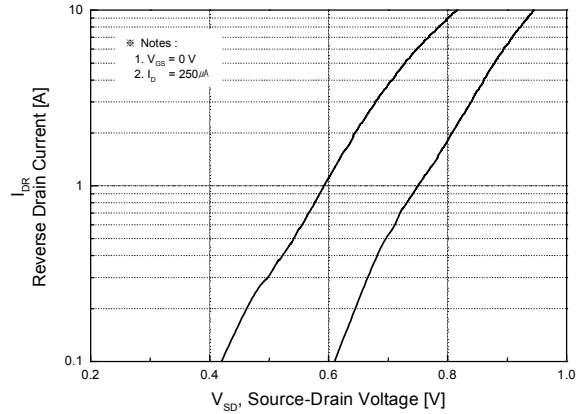


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

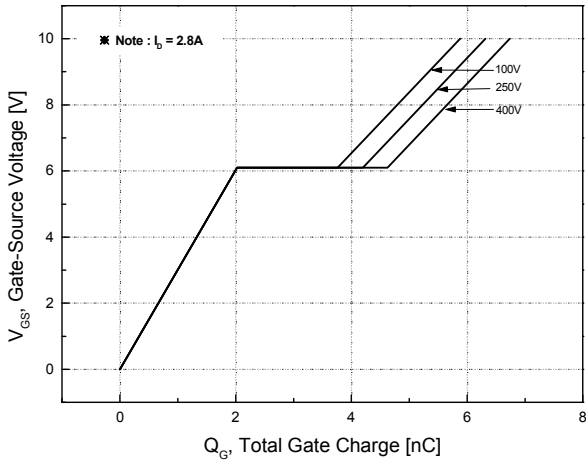


Fig.7 Gate Charge Characteristics

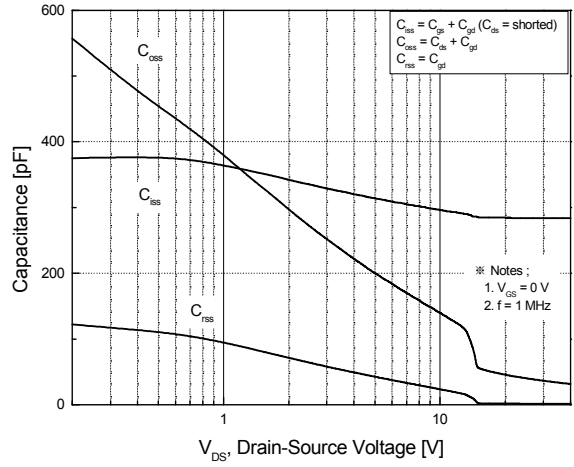


Fig.8 Capacitance Characteristics

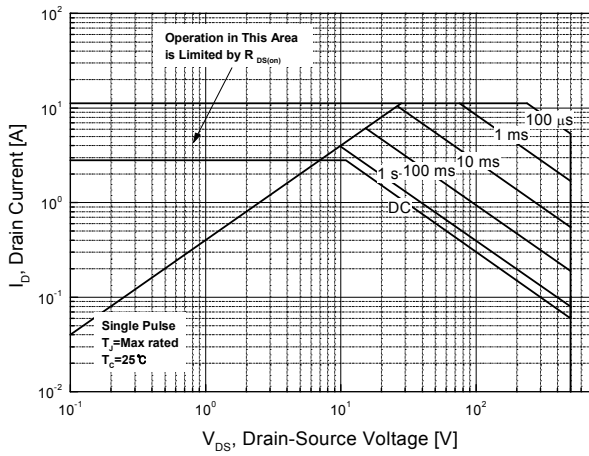


Fig.9 Maximum Safe Operating Area

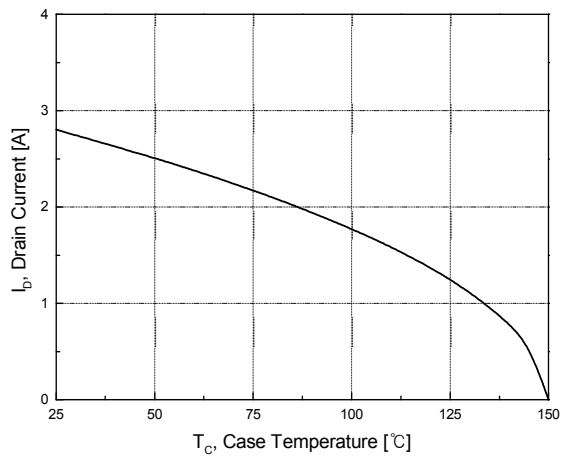


Fig.10 Maximum Drain Current vs. Case Temperature

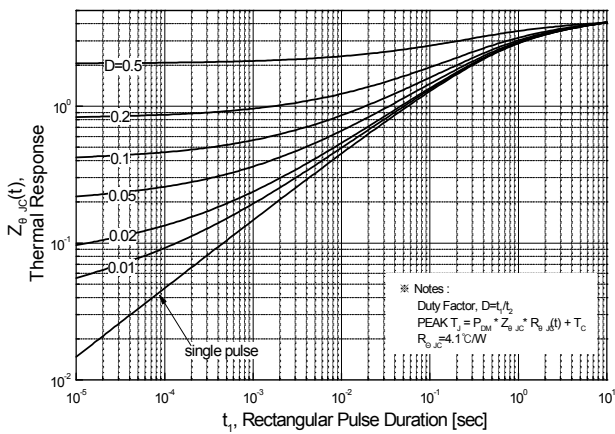


Fig.11 Transient Thermal Response Curve

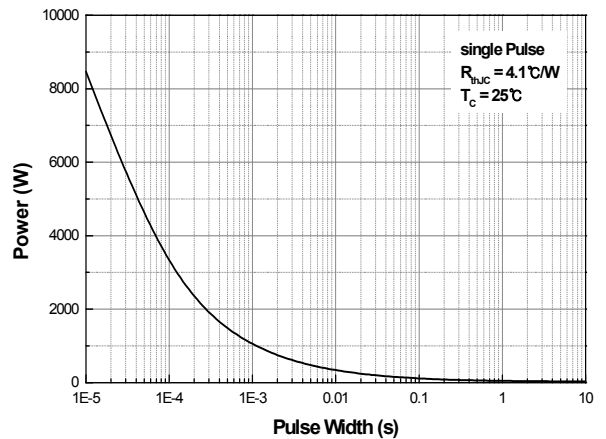
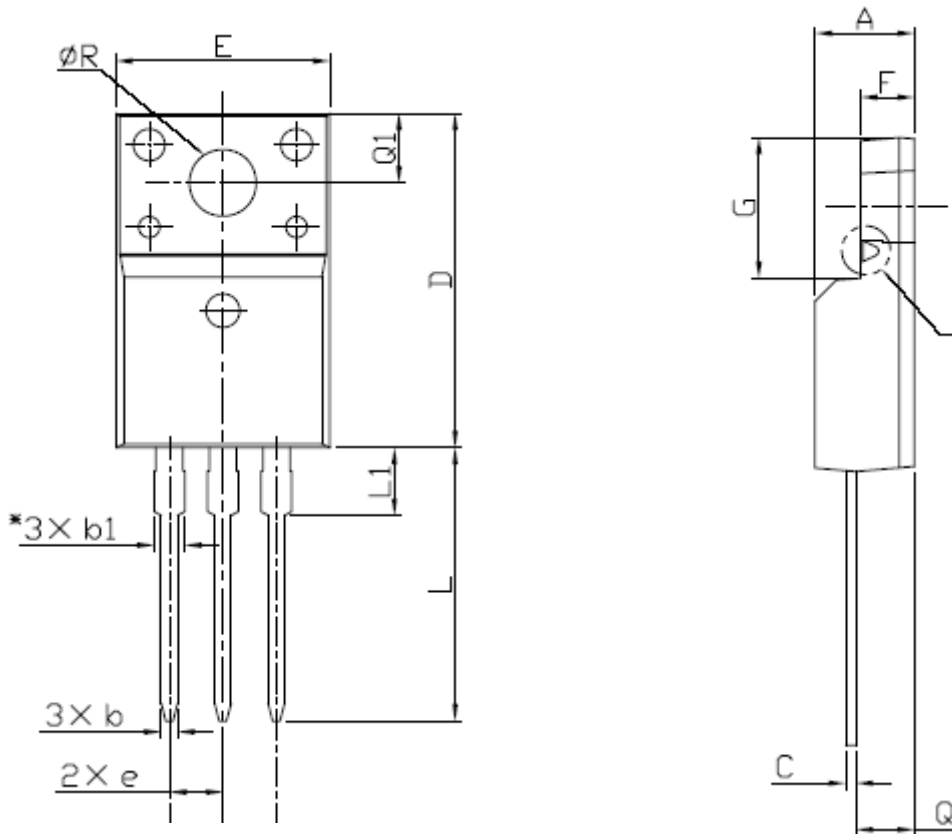


Fig.12 Single Pulse Maximum Power Dissipation

Physical Dimension

3 Leads, TO-220F

Dimensions are in millimeters, unless otherwise specified



Symbol	Min	Nom	Max
A	4.50		4.93
b	0.63		0.91
b1	1.15		1.47
C	0.33		0.63
D	15.47		16.13
E	9.60		10.71
e		2.54	
F	2.34		2.84
G	6.48		6.90
L	12.24		13.72
L1	2.79		3.67
Q	2.52		2.96
Q1	3.10		3.50
$\varnothing R$	3.00		3.55

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